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October 2010

FPF1207 / FPF1208 IntelliMAX[™] Advanced Load Switch

Features

FAIRCHILD SEMICONDUCTOR

- 1.2V to 4.0V Input Voltage Operating Range
- Typical R_{ON}: 50mΩ at V_{IN}=3.3V
 77mΩ at V_{IN}=1.8V
 150mΩ at V_{IN}=1.2V
- Slew Rate Control with t_R: 110µs
- Output Discharge Function on FPF1208
- Low <1.5µA Quiescent Current</p>
- Extra Low <100nA Off Supply Current</p>
- ESD Protected: Above 7000V HBM, 2000V CDM
- GPIO/CMOS-Compatible Enable Circuitry
- 4-Bump WLCSP 0.76mm x 0.76mm, 0.4mm Pitch

Applications

- Mobile Devices and Smart Phones
- Portable Media Devices
- Ultra-Portable / Mobile Computing
- Advanced Notebook, UMPC, MID
- Portable Medical Devices

Ordering Information

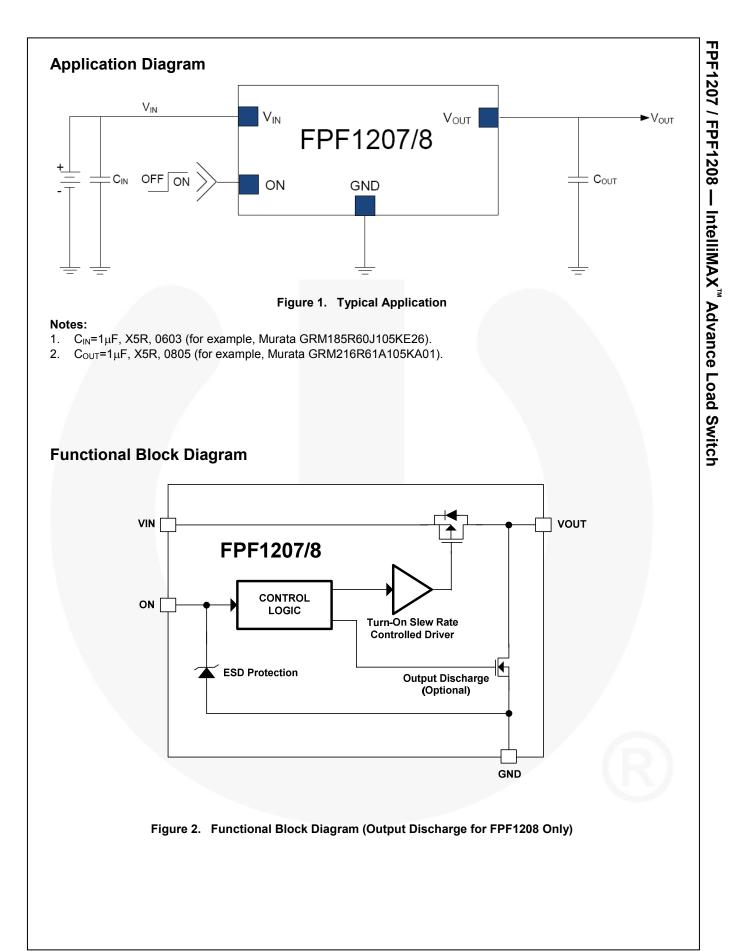
GPS and Navigation Equipment

Description

The FPF1207/08 is an ultra-small integrated IntelliMAX[™] load switch with integrated P-channel switch and analog control features. Integrated slew-rate control prevents inrush current and the resulting excessive voltage drop on power rail. The input voltage range operates from 1.2V to 4.0V to provide power-disconnect capability for post-regulated power rails in portable and consumer products. The low shut-off current of 1µA (maximum) allows power designs to meet standby and off-power drain specifications.

The FPF1207/08 is controlled by an active-HIGH logic input (ON pin) compatible with standard CMOS GPIO circuitry found on Field Programmable Gate Array (FPGA) and embedded processors. The FPF1207/08 is available in 0.76mm x 0.76mm 4-bump WLCSP.

Part Number	Top Marking	Switch (Typical) at 3.3V _{IN}	Output Discharge	ON Pin Activity	t _R	Package
FPF1207UCX	QG	50mΩ	NA	Active HIGH	110µs	4-Ball, Wafer-Level Chip-
FPF1208UCX	QH	50mΩ	65Ω	Active HIGH	110µs	Scale Package (WLCSP), 0.76 x 0.76mm, 0.4mm Pitch



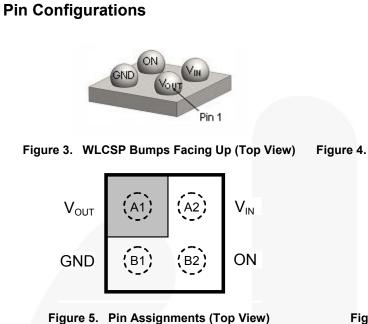
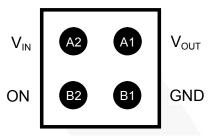




Figure 4. WLCSP Bumps Facing Down (Bottom View)





Pin Definitions

Pin #	Name	Description
A1	V _{OUT}	Switch Output
A2	V _{IN}	Supply Input: Input to the power switch
B1	GND	Ground
B2	ON	ON/OFF control, active HIGH

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Paramete	Min.	Max.	Unit		
V _{IN}	V _{IN} , V _{OUT} , V _{ON} to GND		-0.3	4.2	V	
Isw	Maximum Continuous Switch Current			1.2	А	
PD	Power Dissipation at T _A =25°C			1.0	W	
T _{STG}	Storage Junction Temperature		-65	+150	°C	
T _A	Operating Temperature Range		-40	+85	°C	
0	Thermal Desistance, lunction to Ambient	1S2P with One Thermal Via	110		°C/W	
Θ_{JA}	Thermal Resistance, Junction-to-Ambient	1S2P without Thermal Via		95	C/vv	
ESD	Electrostatic Discharge Canability (^{3,4})	Human Body Model, JESD22-A114	7		kV	
ESD	Electrostatic Discharge Capability ^(3,4)	Charged Device Model, JESD22-C101	2		κv	

Notes:

- 3. Measured using 2S2P JEDEC std. PCB.
- 4. Measured using 2S2P JEDEC PCB COLD PLATE Method.

Recommended Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to Absolute Maximum Ratings.

Symbol	Parameter	Min.	Max.	Unit
VIN	Supply Voltage	1.2	4.0	V
T _A	Ambient Operating Temperature -40 +85 °		°C	

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Units	
asic Ope	ration						
VIN	Supply Voltage		1.2		4.0	V	
I _{Q(OFF)}	Off Supply Current	V _{ON} =GND, V _{OUT} =Open, V _{IN} =4V			100	nA	
$I_{SD(OFF)}$	Off Switch Current	V _{ON} =GND, V _{OUT} =GND			1	μA	
lq	Quiescent Current	I _{OUT} =0mA			1.5	μA	
		V_{IN} =3.3V, I_{OUT} =200mA, T_A =25°C		50	66		
D	On Desistance	V _{IN} =1.8V, I _{OUT} =200mA, T _A =25°C		77	91		
R _{ON}	On Resistance	V _{IN} =1.2V, I _{OUT} =200mA, T _A =25°C		150	160	— mΩ —	
		V _{IN} =1.8V, I _{OUT} =200mA, T _A =85°C			100		
R _{PD}	Output Discharge RPULL DOWN	V _{IN} =3.3V, V _{ON} =0V, I _{FORCE} =20mA, T _A =25°C, FPF1208		65	110	Ω	
		V _{IN} <1.5V	0.9			V	
Vih	On Input Logic HIGH Voltage	V _{IN} =1.5V to 4.0V	1.1			V	
VIL	On Input Logic LOW Voltage	V _{IN} =1.2V to 4.0V			0.75	V	
I _{ON}	On Input Leakage	V _{ON} =V _{IN} or GND			1	μA	
ynamic C	haracteristics ⁽⁵⁾						
t _{DON}	Turn-On Delay ⁽⁶⁾			110			
t _R	V _{OUT} Rise Time ⁽⁶⁾	V _{IN} =3.3V, R _L =10Ω, C _L =0.1µF, T _A =25°C		110		μs	
t _{ON}	Turn-On Time ⁽⁶⁾			220			
t _{DOFF}	Turn-Off Delay ⁽⁶⁾			7			
t⊨	V _{OUT} Fall Time ⁽⁶⁾	V _{IN} =3.3V, R _L =10Ω, C _L =0.1µF, T _A =25°C, FPF1207		2		μs	
t _{OFF}	Turn-Off Time ⁽⁶⁾	T _A -23 0, 111 1207		9			
t _{DOFF}	Turn-Off Delay			2.0			
t⊨	V _{OUT} Fall Time	V _{IN} =3.3V, R _L =10Ω, C _L =0.1µF, T _A =25°C, FPF1208		1.9		μs	
t _{OFF}	Turn-Off Time			3.9			
t _{DOFF}	Turn-Off Delay		7	10			
t⊨	V _{OUT} Fall Time	V _{IN} =3.3V, R _L =500Ω, C _L =0.1µF, T _A =25°C, FPF1207		95		μs	
toff	Turn-Off Time ⁽⁶⁾		<u></u>	105			
t _{DOFF}	Turn-Off Delay			7.0			
t⊨	V _{OUT} Fall Time	V _{IN} =3.3V, R _L =500Ω, C _L =0.1μF, T _A =25°C, FPF1208 ⁽⁷⁾		10.5		μs	
t _{OFF}	Turn-Off Time ⁽⁶⁾	- 1A-20 0, 111 1200		17.5			

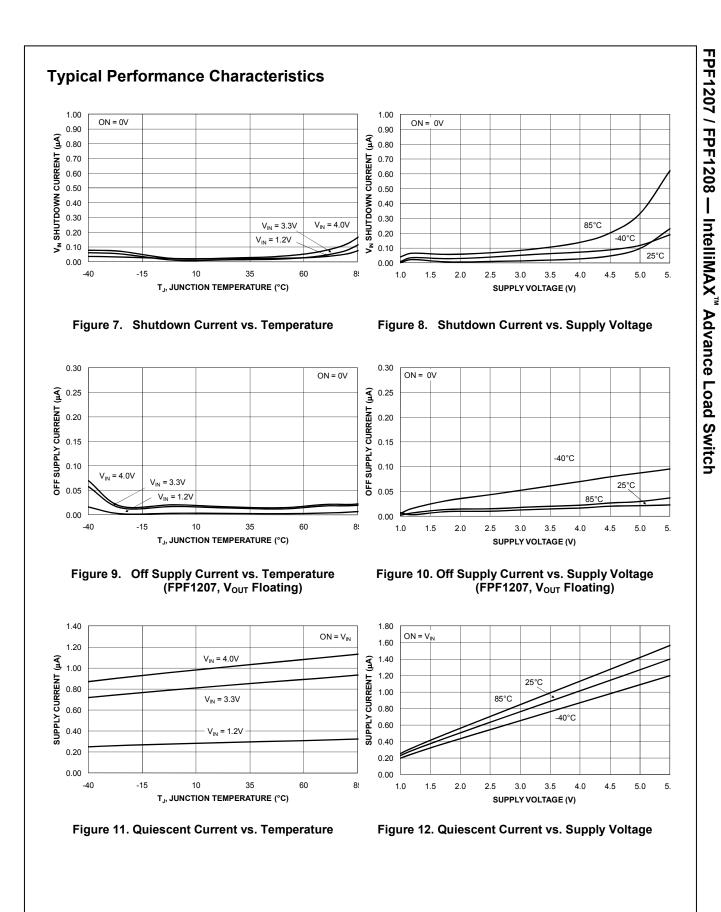
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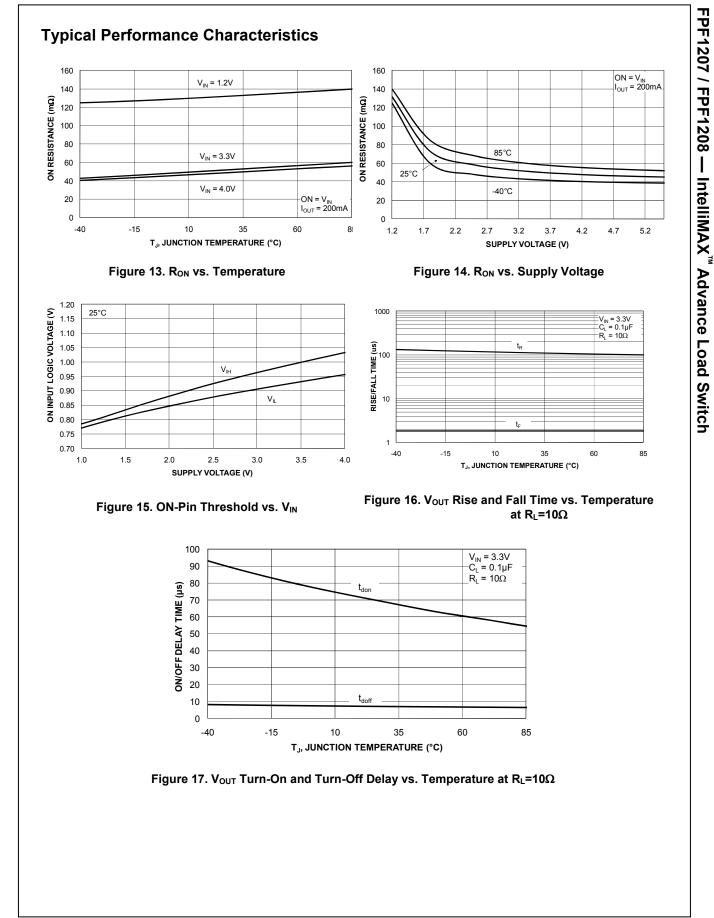
These parameters are guaranteed by design and characterization; not production tested. $t_{DON}/t_{DOFF}/t_R/t_F$ are defined in Figure 25. Output discharge path is enabled during device off. 5.

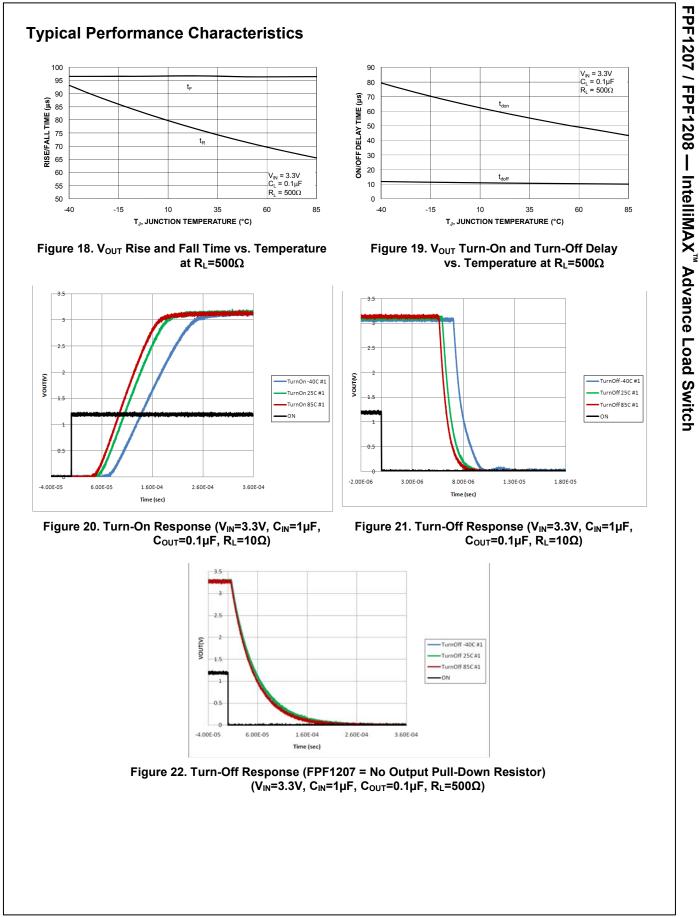
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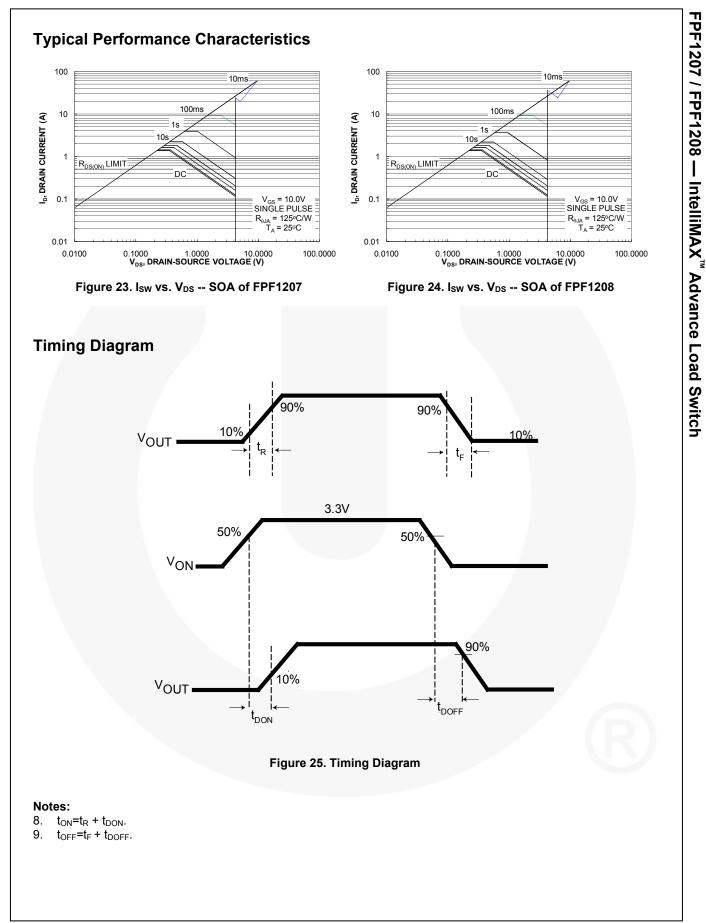
Electrical Characteristics

7.









Operation and Application Description

The FPF1207 and FPF1208 are low-R_{ON} P-channel load switches with controlled turn-on. The core of each device is a 50m Ω P-channel MOSFET and controller capable of functioning over a wide input operating range of 1.2-4.0V. The ON pin, an active HIGH GIOP/CMOS-compatible input, controls the state of the switch.

The FPF1208 contains a 65Ω on-chip load resistor for quick output discharge when the switch is turned off.

Input Capacitor

To limit the voltage drop on the input supply caused by transient inrush current when the switch turns on into a discharged load capacitor or short-circuit, a capacitor must be placed between the V_{IN} and GND pins. A 1 μ F ceramic capacitor, C_{IN}, placed close to the pins is usually sufficient. Higher-value C_{IN} can be used to reduce the voltage drop in higher-current applications.

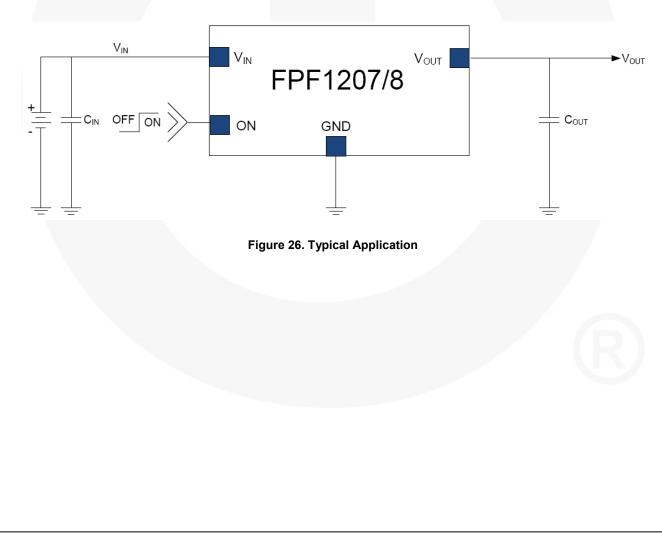
Output Capacitor

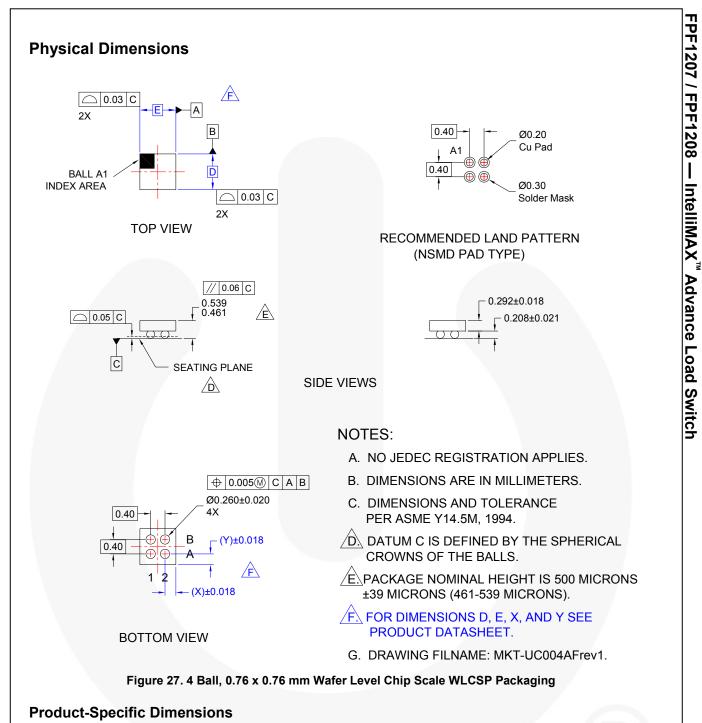
A 0.1 μF capacitor, $C_{OUT},$ should be placed between the V_{OUT} and GND pins. This capacitor prevents parasitic

board inductance from forcing V_{OUT} below GND when the switch is on. C_{IN} greater than C_{OUT} is highly recommended. C_{OUT} greater than C_{IN} can cause V_{OUT} to exceed V_{IN} when the system supply is removed. This could result in current flow through the body diode from V_{OUT} to V_{IN}.

Board Layout

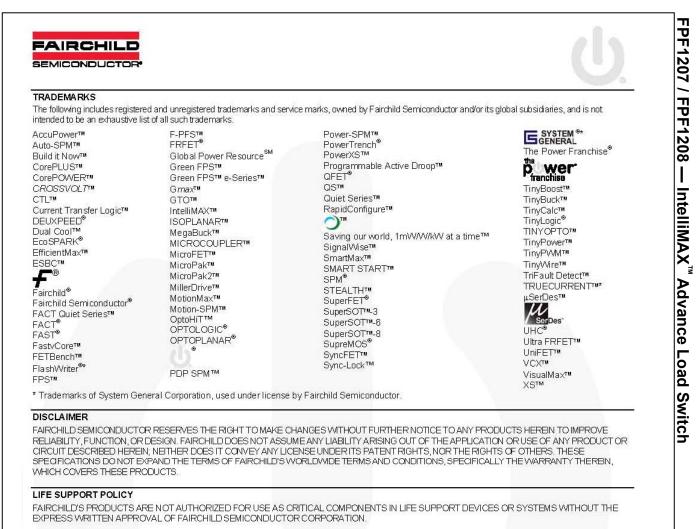
For best performance, all traces should be as short as possible. To be most effective, the input and output capacitors should be placed close to the device to minimize the effect that parasitic trace inductance may have on normal and short-circuit operation. Using wide traces or large copper planes for all pins (V_{IN} , V_{OUT} , ON, and GND) helps minimize the parasitic electrical effects along with minimizing the case ambient thermal impedance. However, the V_{OUT} pin of FPF1208 should not connect directly the battery source due to the discharge mechanism of the load switch.





Product	D	E	X	Y
FPF1207UCX	760µm ± 30µm	760µm ± 30µm	0.180mm± 0.018µm	0.180mm± 0.018µm
FPF1208UCX	760µm ± 30µm	760um ± 30µm	0.180mm± 0.018µm	0.180mm± 0.018µm

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